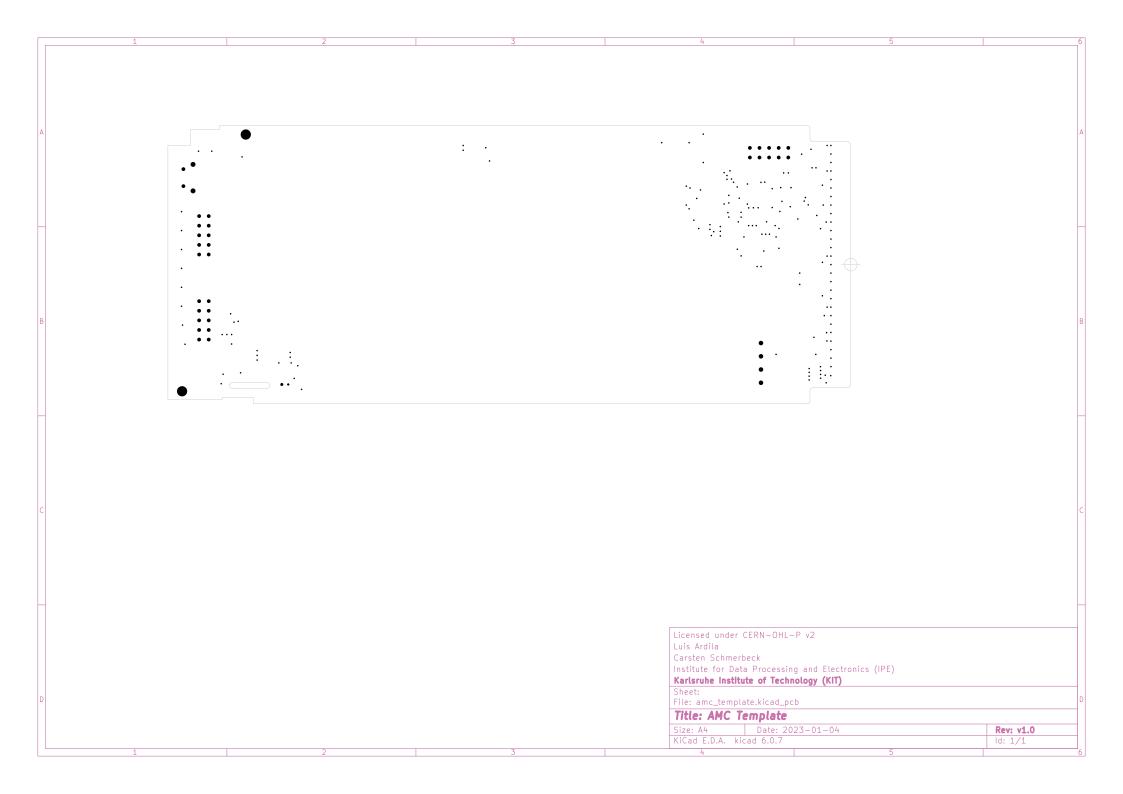
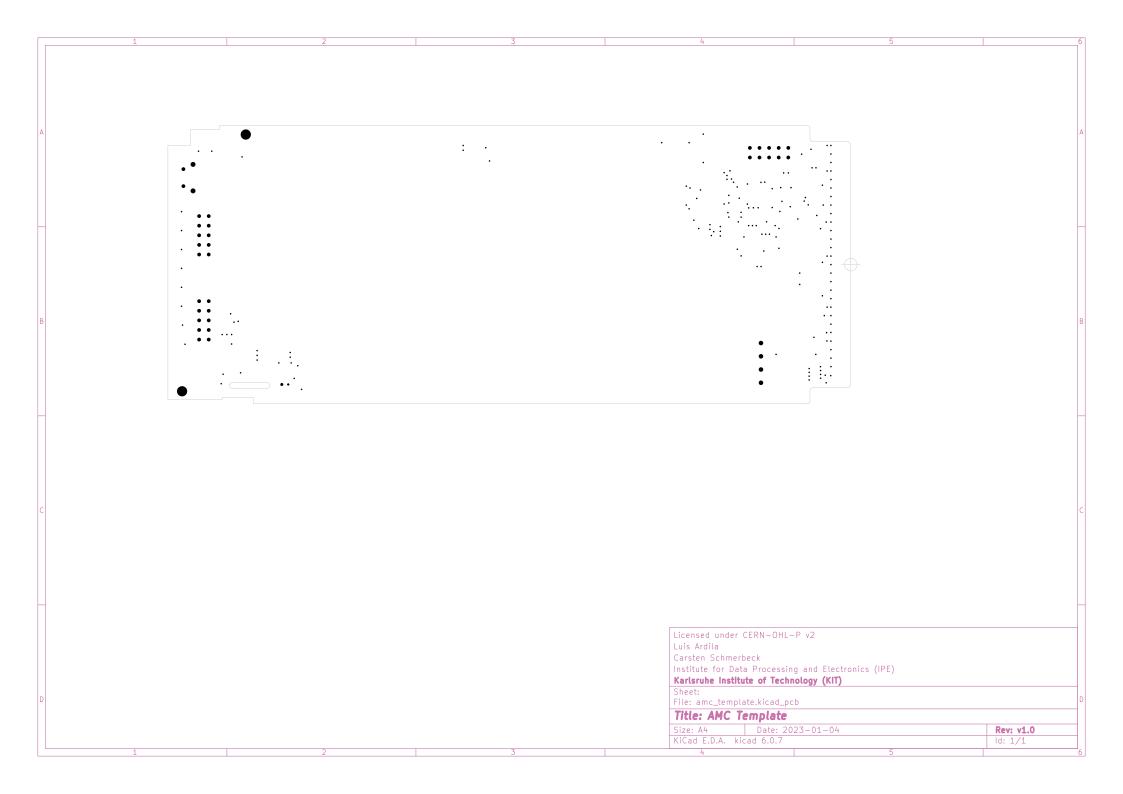
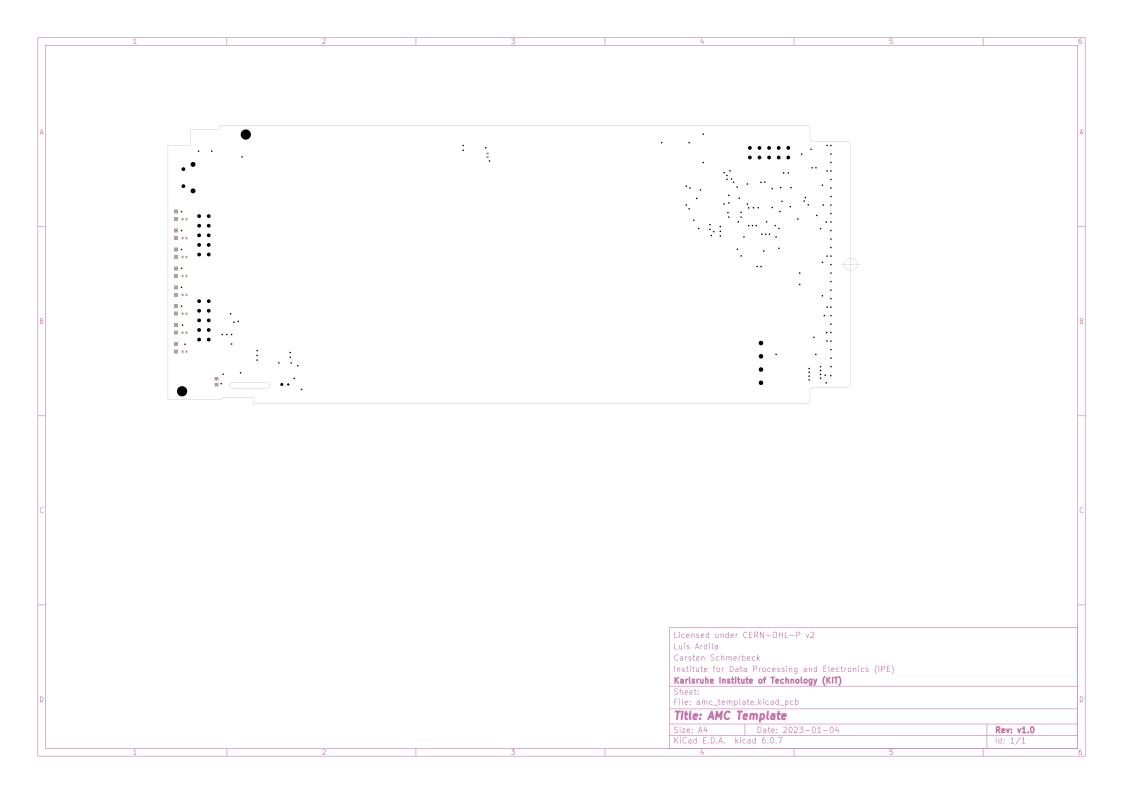


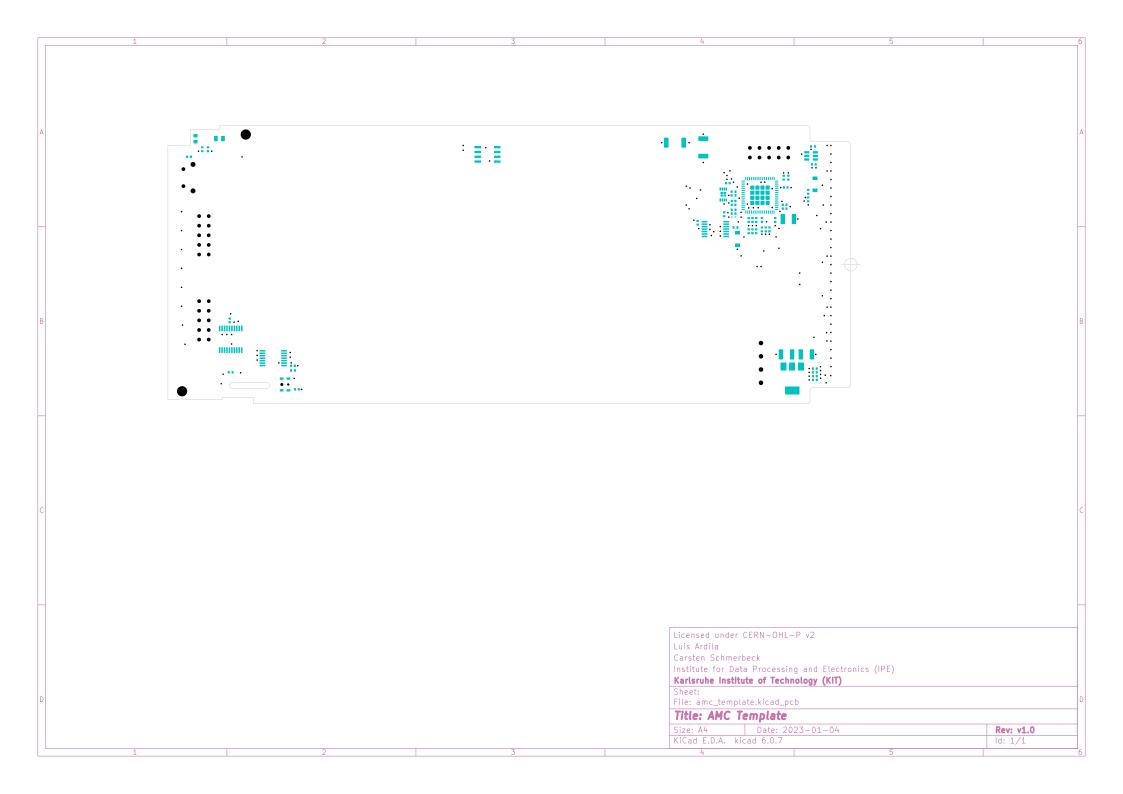
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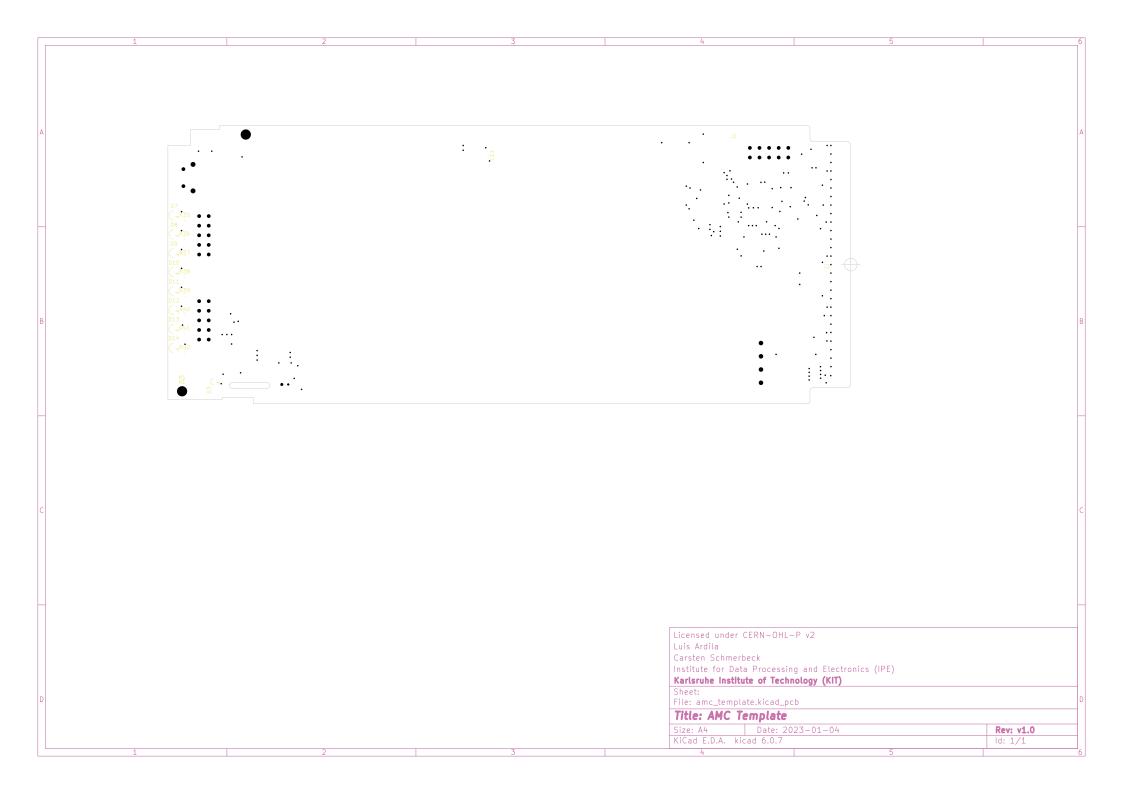
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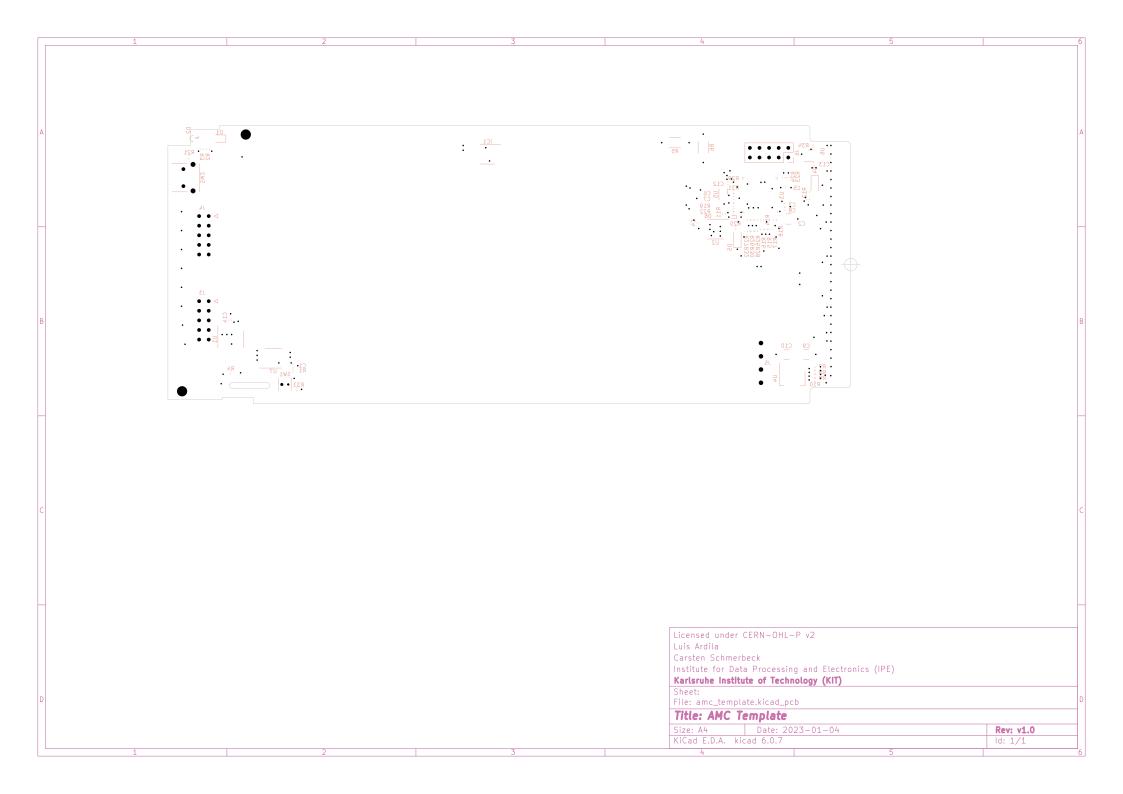


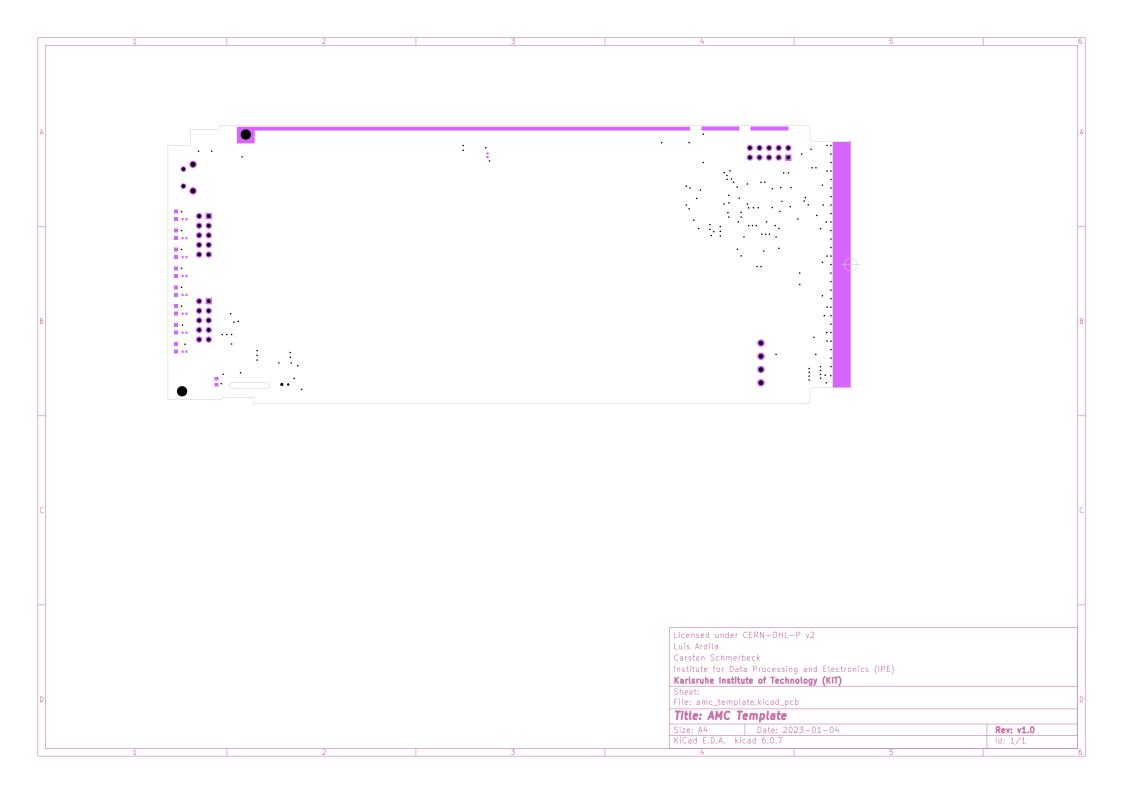


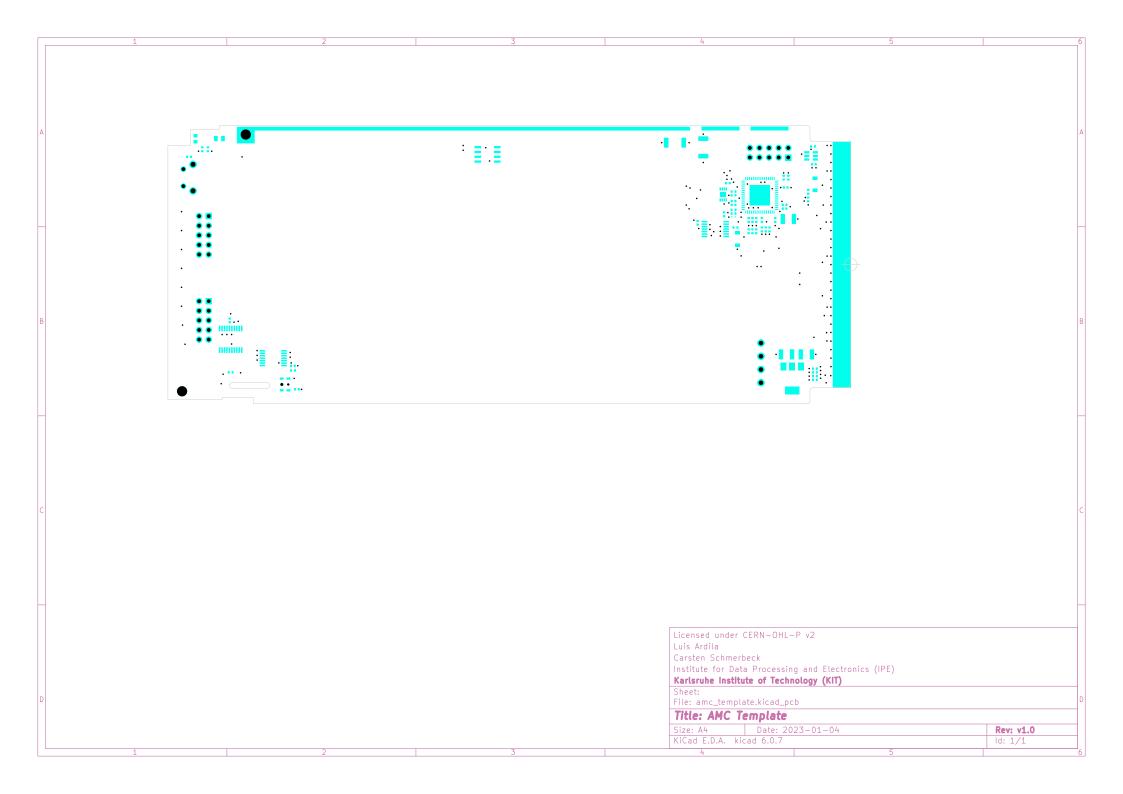


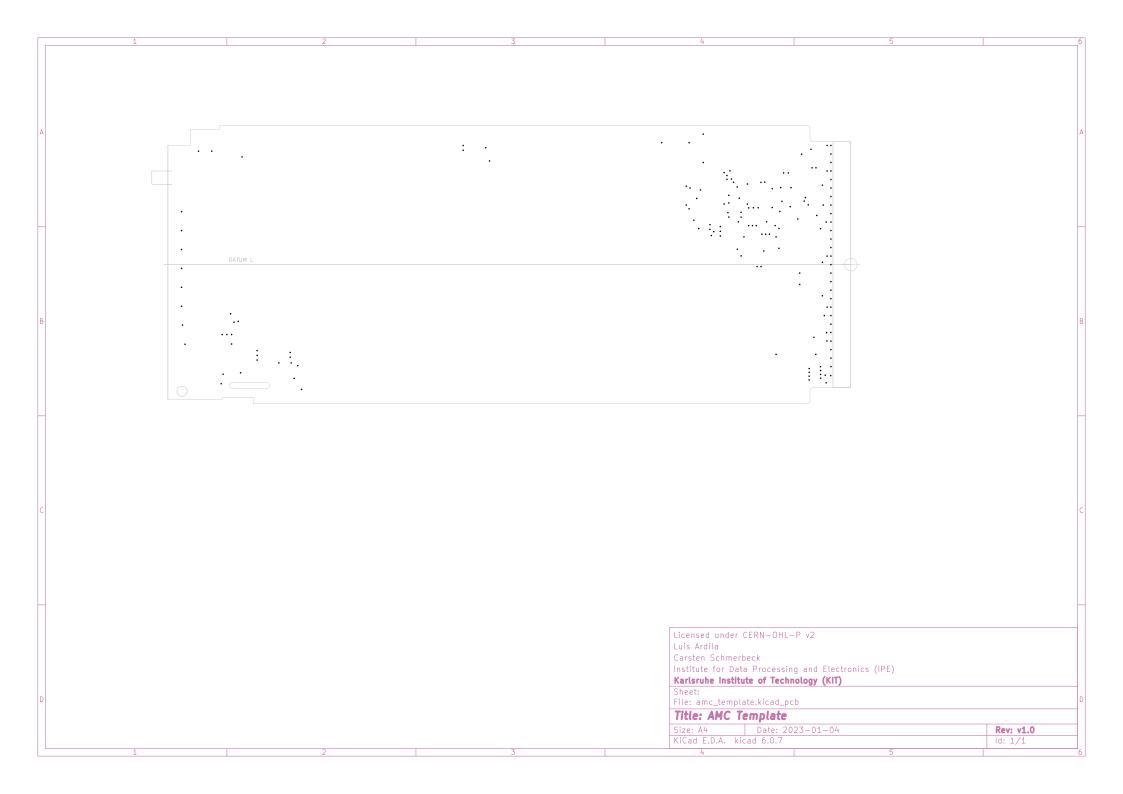












Component Side 2 (TOP)
Maximum component height 3.6mm
Component Side 1 (SOT)
Maximum component height 23.25mm

## PCB thickness 1,6mm

Lagenname	Тур	Material	Dicke (mm)	Farbe	Epsilon R	Verlustwinkel
F.Silkscreen	Top Silk Screen	Not specified	0 mm	White	1	0
F.Paste	Top Solder Paste		0 mm		1	0
F.Mask	Top Solder Mask	Not specified	0,01 mm	Green	3,3	0
F.Cu	copper		0,035 mm		1	0
Dielektrikum	core	FR4	0,135 mm		4,5	0,02
In1.Cu	copper		0,018 mm		1	0
Dielektrikum	prepreg	FR4	1,204 mm		4,5	0,02
In2.Cu	copper		0,018 mm		1	0
Dielektrikum	core	FR4	0,135 mm		4,5	0,02
B.Cu	copper		0,035 mm		1	0
B.Mask	Bottom Solder Mask	Not specified	0,01 mm	Green	3,3	0
B.Paste	Bottom Solder Paste		0 mm		1	0
B.Silkscreen	Bottom Silk Screen	Not specified	0 mm	White	1	0

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Sheet:

File: amc\_template.kicad\_pcb

Title:	AMC	Temp	late

 Size: A4
 Date: 2023-01-04
 Rev: v1.0

 KiCad E.D.A. kicad 6.0.7
 Id: 1/1

